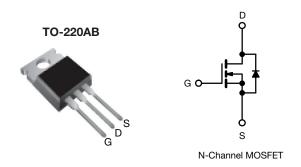
SiHP052N60EF



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EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.045		
Q _g max. (nC)	101			
Q _{gs} (nC)	24			
Q _{gd} (nC)	22			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP052N60EF-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain current ($T_{1} = 150 \ ^{\circ}C$)	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I _D	48	А	
Continuous drain current $(1j = 150 \text{ C})$				31		
Pulsed drain current ^a			I _{DM}	148		
Linear derating factor				2.2	W/°C	
Single pulse avalanche energy ^b			E _{AS}	353	mJ	
Maximum power dissipation			PD	278	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100		
Reverse diode dv/dt ^d				50	V/ns	
Soldering recommendations (peak temperature) ^c	For	10 s		260	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 240 A/µs, starting T_J = 25 °C

COMPLIANT

HALOGEN

FREE



PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62				
Maximum junction-to-case (drain)	R _{thJC}	-	- 0.45			°C/W		
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherw	ise noted)						
PARAMETER	SYMBOL			NS	MIN.	TYP.	MAX.	
Static		-						
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 25	0 μA	600	-	-	V
V _{DS} temperature coefficient	ΔV _{DS} /T _J		e to 25 °C, I _E		-	0.61	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 25		3.0	-	5.0	V
		-	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 V$		-	-	± 1	μA
	<u> </u>		= 480 V, V _{GS} =	= 0 V	-	-	1	μA
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-	2	mA	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	T	= 23 A	-	0.045	0.052	Ω
Forward transconductance a	g _{fs}		= 30 V, I _D = 2	23 A	-	11	-	S
Dynamic		1 -				•	1	
Input capacitance	C _{iss}		V _{GS} = 0 V,		-	3380	-	
Output capacitance	C _{oss}	$V_{GS} = 0.V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	158	-	pF	
Reverse transfer capacitance	C _{rss}			-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}	- V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	116	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	715	-		
Total gate charge	Qg	V _{GS} = 10 V I _D = 23 A, V _{DS} = 480 V		-	67	101	nC	
Gate-source charge	Q _{gs}			-	24	-		
Gate-drain charge	Q _{gd}				-	22	-	1
Turn-on delay time	t _{d(on)}				-	31	62	
Rise time	t _r	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 23 \text{ A}, \\ V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	80	160	- ns	
Turn-off delay time	t _{d(off)}			-	68	136		
Fall time	t _f			-	50	100		
Gate input resistance	Rg	f = 1 MHz, open drain		0.4	0.8	1.6	Ω	
Drain-Source Body Diode Characterist		•						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	48	- A	
Pulsed diode forward current	I _{SM}			-	-	148		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 23 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}		- /		-	148	296	ns
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S =		-	1.1	1.2	μC
Reverse recovery current	I _{RRM}	di/dt = 1	di/dt = 100 A/µs, V _R = 400 V		_	14	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

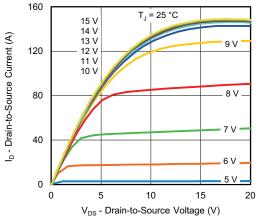


Fig. 1 - Typical Output Characteristics

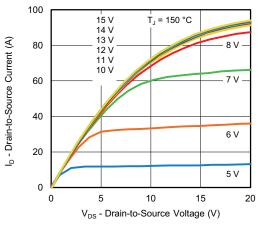


Fig. 2 - Typical Output Characteristics

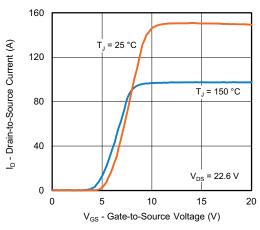


Fig. 3 - Typical Transfer Characteristics

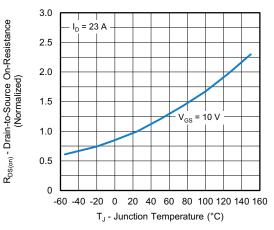


Fig. 4 - Normalized On-Resistance vs. Temperature

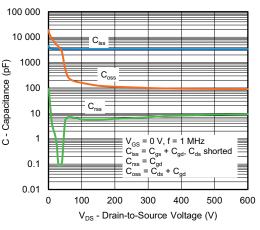
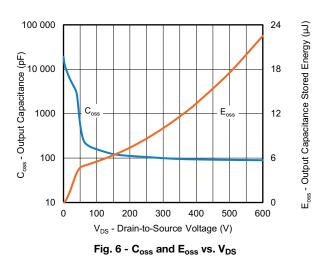


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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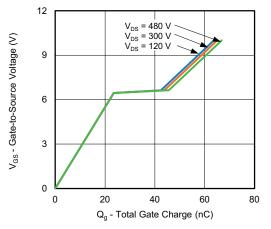


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

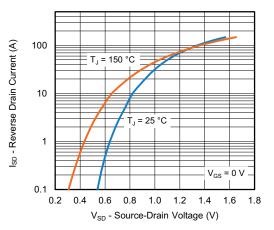


Fig. 8 - Typical Source-Drain Diode Forward Voltage

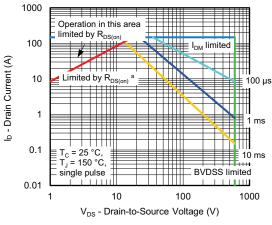


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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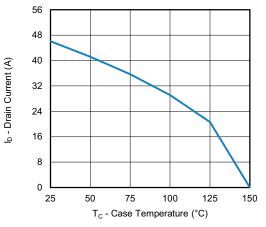


Fig. 10 - Maximum Drain Current vs. Case Temperature

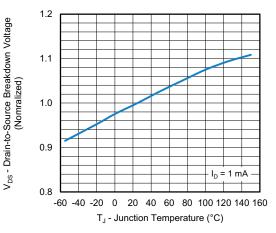
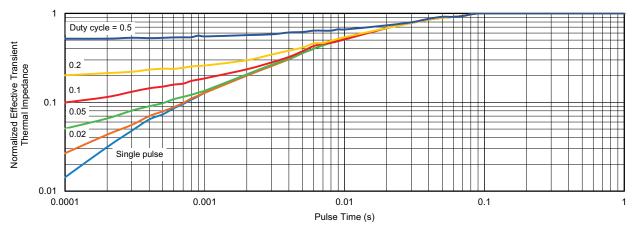


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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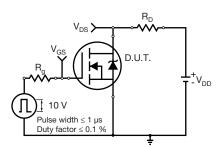


Fig. 13 - Switching Time Test Circuit

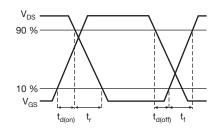


Fig. 14 - Switching Time Waveforms

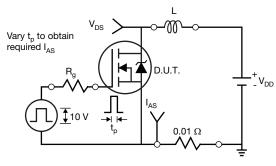
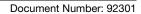
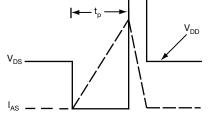


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

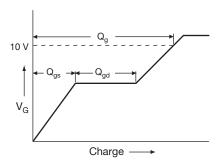
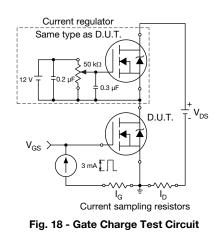


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dv/dt Test Circuit

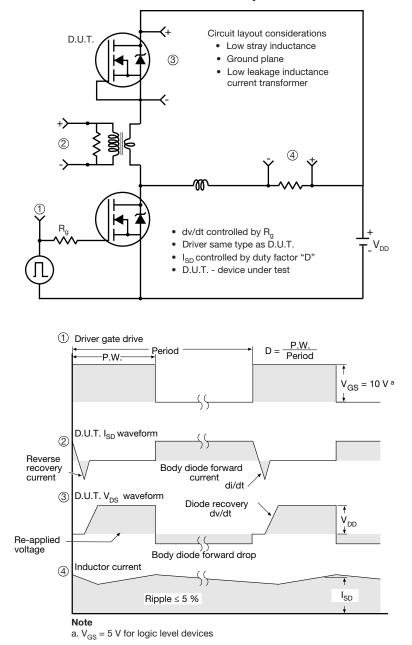


Fig. 19 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	IN	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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